

# **NP89N055MUK, NP89N055NUK** MOS FIELD EFFECT TRANSISTOR

R07DS0600EJ0200 Rev.2.00 May 24, 2018

# Description

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

# Features

- Super low on-state resistance  $R_{DS(on)} = 4.4 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, I_D = 45 \text{ A})$
- Low  $C_{iss}$ :  $C_{iss} = 4000 \text{ pF TYP}$ . ( $V_{DS} = 25 \text{ V}$ )
- Designed for automotive application and AEC-Q101 qualified

# **Ordering Information**

Part No.	Lead Plating	Packing	Package
NP89N055MUK-S18-AY *1	Pure Sn (Tin)	Tube 50 p/tube	TO-220 (MP-25K)
NP89N055NUK-S18-AY *1			TO-262 (MP-25SK)

Note: \*1 Pb-free (This product does not contain Pb in the external electrode)

# **Absolute Maximum Ratings** (T<sub>A</sub> = 25°C)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V <sub>GS</sub> = 0 V)	V <sub>DSS</sub>	55	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	±20	V
Drain Current (DC) ( $T_c = 25^{\circ}C$ )	ID(DC)	±90	A
Drain Current (pulse) *1, 3	I <sub>D(pulse)</sub>	±360	A
Total Power Dissipation ( $T_c = 25^{\circ}C$ )	P <sub>T1</sub>	147	W
Total Power Dissipation ( $T_A = 25^{\circ}C$ )	P <sub>T2</sub>	1.8	W
Channel Temperature	T <sub>ch</sub>	175	°C
Storage Temperature	T <sub>stg</sub>	–55 to 175	°C
Repetitive Avalanche Current *2, 3	lar	33	A
Repetitive Avalanche Energy *2, 3	Ear	108	mJ

# **Thermal Resistance**

Channel to Case Thermal Resistance	R <sub>th(ch-C)*3</sub>	1.02	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A) *3	83.3	°C/W

Notes: \*1 T<sub>C</sub> = 25°C, P<sub>W</sub>  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

\*2 R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V

\*3 Not subject of production test. Verified by design/characterization.



# **Electrical Characteristics** (T<sub>A</sub> = 25°C)

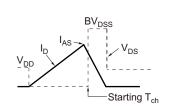
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	1	μA	V <sub>DS</sub> = 55 V, V <sub>GS</sub> = 0 V	
Gate Leakage Current	I <sub>GSS</sub>			±100	nA	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V	
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	2.0	3.0	4.0	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	
Forward Transfer Admittance *1	y <sub>fs</sub>	30	60	—	S	$V_{DS}$ = 5 V, $I_{D}$ = 45 A	
Drain to Source On-state Resistance *1	R <sub>DS(on)</sub>	—	3.65	4.40	mΩ	$V_{GS}$ = 10 V, I <sub>D</sub> = 45 A	
Input Capacitance *2	Ciss	—	4000	6000	pF	V <sub>DS</sub> = 25 V	
Output Capacitance *2	Coss	—	410	620	pF	$V_{GS} = 0 V$	
Reverse Transfer Capacitance *2	Crss	—	150	270	pF	f = 1 MHz	
Turn-on Delay Time *2	t <sub>d(on)</sub>	—	25	60	ns	V <sub>DD</sub> = 28 V, I <sub>D</sub> = 45 A	
Rise Time *2	tr	—	10	30	ns	V <sub>GS</sub> = 10 V	
Turn-off Delay Time *2	t <sub>d(off)</sub>	—	65	130	ns	$R_G = 0 \Omega$	
Fall Time *2	t <sub>f</sub>	—	6	20	ns		
Total Gate Charge *2	$Q_{G}$	—	68	102	nC	V <sub>DD</sub> = 44 V	
Gate to Source Charge	Q <sub>GS</sub>	—	18	_	nC	V <sub>GS</sub> = 10 V	
Gate to Drain Charge	Q <sub>GD</sub>	_	18	_	nC	I <sub>D</sub> = 90 A	
Body Diode Forward Voltage *1	V <sub>F(S-D)</sub>	_	0.95	1.5	V	I <sub>F</sub> = 90 A, V <sub>GS</sub> = 0 V	
Reverse Recovery Time	trr	_	47	_	ns	I <sub>F</sub> = 90 A, V <sub>GS</sub> = 0 V	
Reverse Recovery Charge	Qrr	_	80		nC	di/dt = 100 A/µs	

Note: \*1 Pulsed test

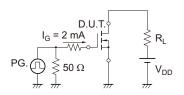
Note: \*2 Not subject of production test. Verified by design/characterization.

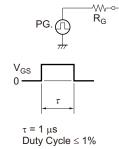
### TEST CIRCUIT 1 AVALANCHE CAPABILITY

#### 



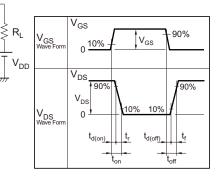
### **TEST CIRCUIT 3 GATE CHARGE**





**TEST CIRCUIT 2 SWITCHING TIME** 

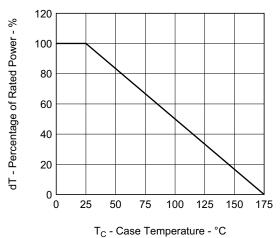
D.U.T.

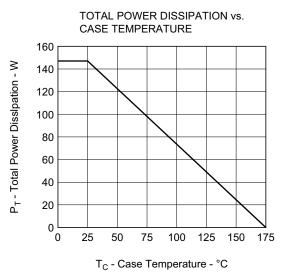




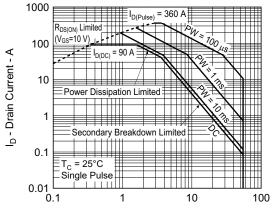
# **Typical Characteristics** (T<sub>A</sub> = 25°C)

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



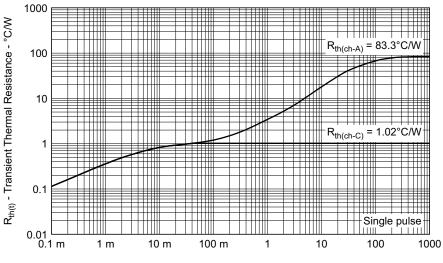


FORWARD BIAS SAFE OPERATING AREA



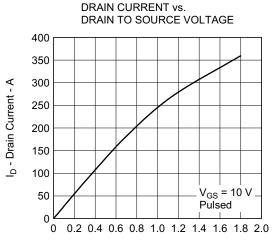


### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

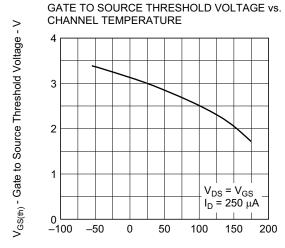


PW - Pulse Width - s

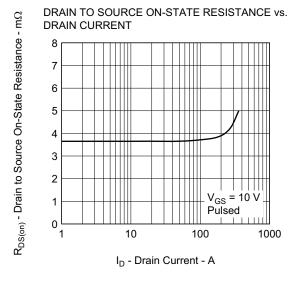




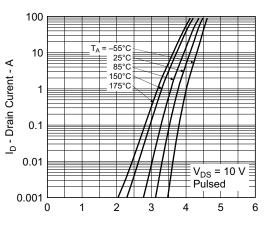
V<sub>DS</sub> - Drain to Source Voltage - V



T<sub>ch</sub> - Channel Temperature - °C

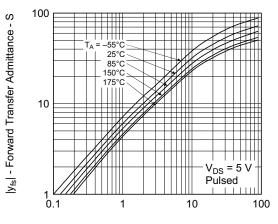


FORWARD TRANSFER CHARACTERISTICS

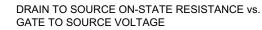


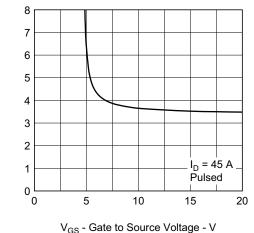


FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



I<sub>D</sub> - Drain Current - A

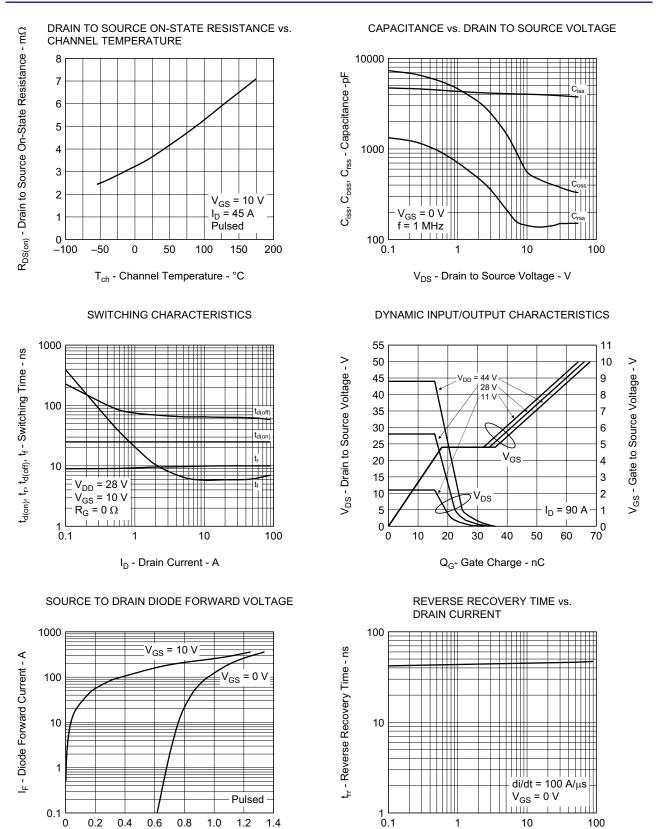


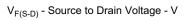


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 $R_{DS(on)}$  - Drain to Source On-State Resistance -  $m\Omega$ 





0.8

1.0

1.2

1.4

0.6

IF - Drain Current - A

10

1

0

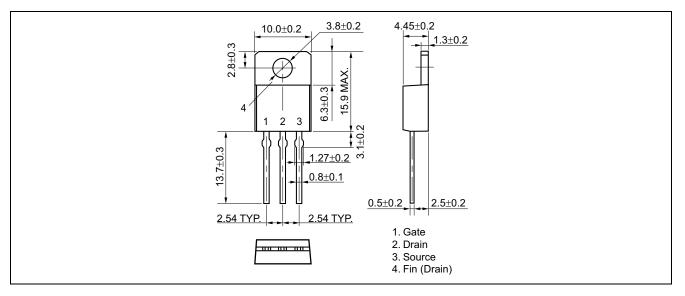
0.2

0.4

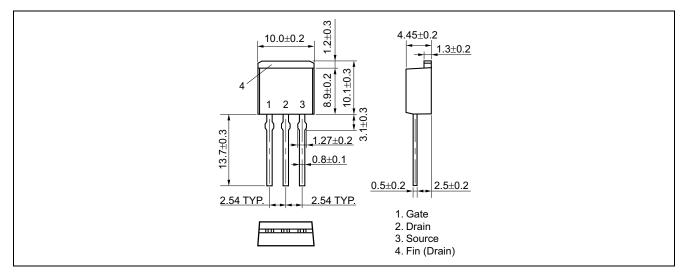
100

# Package Drawing (Unit: mm)

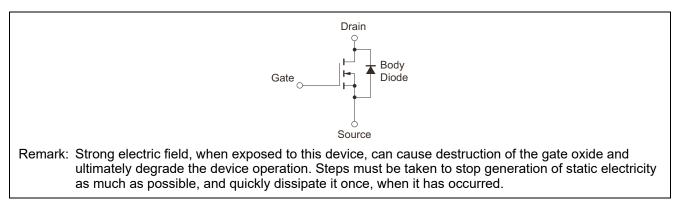
### TO-220 (MP-25K) (Mass: 1.9 g TYP.)



### TO-262 (MP-25SK) (Mass: 1.8 g TYP.)



# **Equivalent Circuit**



**Revision History** 

# NP89N055MUK, NP89N055NUK Data Sheet

		Description				
Rev.	Date	Page	Summary			
1.00	Jan 11, 2012	—	First Edition Issued			
2.00	May 24 ,2018	1	Note 3 was added			
		2	Note 2 was added			

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